

#### 2W Filterless Mono Class-D Audio Amplifier

#### **PRODUCTION DATA SHEET**

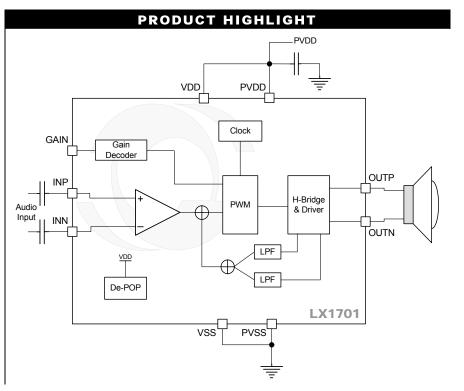
### DESCRIPTION

The LX1701 family represents a powered applications where low external components. power consumption is desirable such and other low power systems.

The LX1701 family provides very new generation of a fully integrated low quiescent current consumption audio mono class-D amplifier from through the use of a proprietary output Microsemi. This CMOS monolithic modulation scheme. This technology class-D amplifier series is optimized enables filter-less operation in many for low voltage, low power operation applications. The part features on board, and minimum system cost. The low Rdson, complementary output products are ideal for use in battery MOSFET's that reduces the need for

The LX1701 is offered in a small as cell phones. PDA's, web tablets footprint, low profile surface mountable 16-pin MLPQ package.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com



PACKAGE ORDER INFO							
T <sub>J</sub> (°C)	Bare Die	LQ Plastic MLPQ 16-Pin					
-40 to 85	LX1701	LX1701CLQ					

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX1701CLQTR)

- No Output Filter Required
- Low EMI Design
- Low Quiescent Current: 2mA
- Low Shutdown Current:1µA
- Low And Wide Supply Voltage Range: 1.8-6.0 Volt
- 2W Output Power Into 4Ω Load With THD<1% 3W Into 2Ω With THD<1%
- THD+N As Low As 0.09%
- Small Form Factor: 16-pin MLPQ Package: 4mmx4mm
- -40 to +85°C Operating Range
- Only 1 External Component Needed, No Input AC Coupling Capacitor Required, Under Certain Conditions
- Built-in Clock Frequency 200KHz
- Built-in Feedback Loop, Allows High Audio Fidelity
- 14dB/8dB Gain Selectable
- 20/300Hz Bandwidth Selectable
- Shut-down Function
- Internal Thermal Shut-down .
- High Efficiency: 85% Through . Modulation Scheme And Class-D Operation
- Built-in De-pop Circuit, No Turn ON/OFF "POP" Noise

### APPLICATIONS/BENEFITS

- PDA's
- Cell Phones .
- Portable Audio .
- Laptop Computer Speaker Amplifier
- LCD TV/Desktop Monitor Speaker Amplifier
- PC Audio Multimedia Amplifier



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### ABSOLUTE MAXIMUM RATINGS

Positive Supply Voltage (VDD, PVDD)	0.3 to 7.0V
Operating Temperature	$\dots -40^{\circ}$ C to $+85^{\circ}$ C
Maximum Operating Junction Temperature	
Storage Temperature	
•	
Package Peak Temp for Solder Reflow(40 second maximum expos	sure) 250°C (+5, -0)
Lead Temperature (Soldering, 10 seconds)	300°C

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

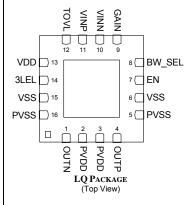
### THERMAL DATA

LQ	Plastic Micro Lead Quad Package 16-Pin	
THER	MAL RESISTANCE-JUNCTION TO CASE, $\theta_{JC}$	
THER	MAL RESISTANCE-JUNCTION TO AMBIENT, $\theta_{JA}$	

Junction Temperature Calculation:  $T_J = T_A + (P_D \ge \theta_{JA})$ .

The  $\theta_{IA}$  numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow. Thermal Test Board: JESD5-7 (Leaded Surface Mount Package)

### PACKAGE PIN OUT



Pb-free 100% Matte Tin Finish

	FUNCTIONAL PIN DESCRIPTION
Name	Description
OUTN	Negative Audio (PWM) Output
PVDD	Positive Supply to Negative Output Stage
PVDD	Positive Supply to Positive Output Stage
OUTP	Positive Audio (PWM) Output
PVSS	Negative Supply to Positive Output Stage (ground)
VSS	Negative Supply to Analog Stage (ground)
EN	Enable Pin, Active High.
BW_SEL	Bandwidth Selection Pin: VDD 300Hz HP filter VSS No HP (< 20Hz)
GAIN	Gain Selection Pin: Tied to VDD Gain = 14dB Tied to VSS Gain = 8dB
VINN	Negative Audio Input
VINP	Positive Audio Input
TOVL	Thermal Overload Indicator Output, Active HIGH.
VDD	Analog Positive Power Supply
3LVL	Three Level Modulation Selection Pin: Tied to VSS 2 LEVEL PWM Modulation Scheme, +PVDD   -PVDD; Tied to VDD 3 LEVEL PWM Modulation Scheme, +PVDD   PVSS   -PVDD;
VSS	Negative Power Supply to Analog Stage
PVSS	Negative Supply to Negative Output Stage (ground)

3.22°C/W 38.1°C/W

#### *Microsemi* Integrated Products Division 11861 Western Avenue, Garden Grove CA. 92841 714-898-8121, FAX 714-893-2570



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### SYSTEM CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature  $T_A = 25^{\circ}C$  except where otherwise noted and the following test conditions: Default settings: 20Hz corner low frequency, 14dB gain.

Parameter	Symbol	Test Conditions		LX1701			Units
Falalletei	Symbol			Min	Тур	Max	Units
	IQQ	No Load, VDD = PVDD = 1.8V			0.9	1.2	mA
Supply Current, Quiescent		No Load, VDD = PVDD = 3.3V			1.3	1.8	
		No Load, VDD = PVDD = 5.0V			2.0	2.5	
Supply Current, Shutdown Mode	IQQSD	Disable pin active				1	μA
		VDD = PVDD = 5V.	THD+N = 1%		1.3		- W
		Fin = 1kHz	THD+N = 10%	ĺ	1.8		
Output Power @ 8 Ohms	PO	VDD = PVDD = 3.3V, Fin = 1kHz	THD+N = 1%		0.5		
			THD+N = 10%		0.7		
	РО	VDD = PVDD = 5V, Fin = 1kHz	THD+N = 1%		2.1		- w
			THD+N = 10%		2.8		
Output Power @ 4 Ohms		VDD = PVDD = 3.3V, Fin = 1kHz	THD+N = 1%		0.9		
			THD+N = 10%		1.2		
	PO	VDD = PVDD = 5V, Fin = 1kHz	THD+N = 1%		3.0		- W
			THD+N = 10%		3.9		
Output Power @ 2 Ohms		VDD = PVDD = 3.3V.	THD+N = 1%		1.3		
		Fin = 1kHz THD+N = 10%			1.8		-
Power Efficiency	η	VDD = PVDD = 5V, Fin =		85		%	
Total Harmonic Distortion @ 50% of Max Power	THD+N	VDD = PVDD = 5V, Fin =	1kHz, RL = 8 Ω		0.09		%
Signal-to-Noise Ratio	SNR	VDD = PVDD = 5V, F = 1 A-Weighted	KHz, PO = 1W,		99		dB
Output Noise Floor	VN	Input Grounded A-weighte	ed 20-20kHz		25		$\mu V_{\text{RMS}}$
Frequency Response Lower Corner	FLO	3dB relative to 1kHz, BW	Select = VSS		20		Hz
Frequency	FHI	3dB relative to 1kHz, BW		300		Hz	
Frequency Response		/DD = PVDD = 1.8 to 5.5V, RL = 4 Ω , PO = 200mW @ 20~80KHz, filterless			3	dB	
Power Supply Rejection Ratio	PSRR	VDD = PVDD = 1.8V to 5	.5V		65		dB
Common Mode Rejection Ratio	CMRR	VDD = PVDD = 1.8V to 5	.5V		70		dB
Cain	0.0270	Pin 9 tied to VDD, VDD = PVDD = 1.8V to 5.5V		İ	14		
Gain	GSYS	Pin 9 tied to VSS, VDD = PVDD = 1.8V to 5.5V			8		dB



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### ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature -40°C  $\leq T_A \leq 85$ °C except where otherwise noted.

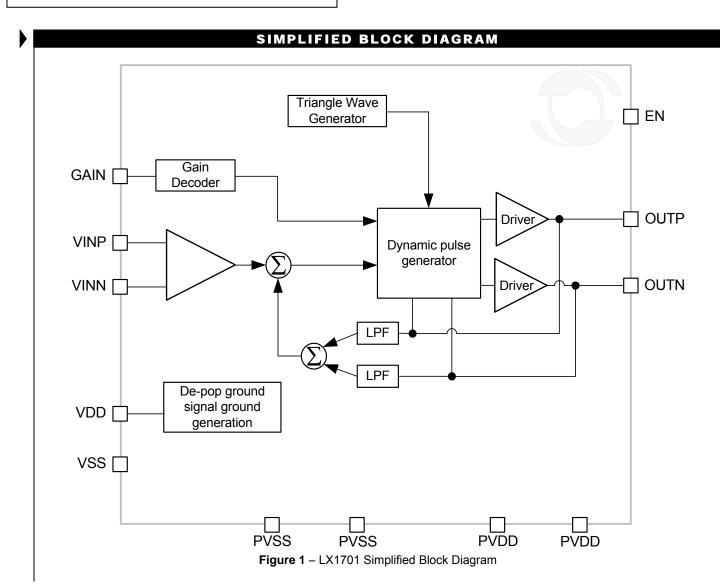
Parameter	Symbol	Test Conditions		LX1701			Units		
Farameter	,			Min	Тур	Max	Units		
Supply Voltage	VDD PVDD			1.8		6.0	V		
Oscillator Frequency	fSW	VDD = PVDD = 1.8~5.5V			180	200	225	KHz	
	IQQ		VDD = F	VDD = 5V		2.0	2.5		
Supply Current, Quiescent		No Load	VDD = PVDD = 3.3V			1.3	1.8	mA	
			VDD = PVDD = 1.8V			0.9	1.2		
Supply Current, Shutdown Mode	IQQSD	Disable Pin ac	tive				1	μA	
Power Supply Rejection Ratio	PSRR	VDD = PVDD	= 1.8V to	5.5V		65		dB	
Common Mode Rejection Ratio	CMRR	VDD = PVDD	= 1.8V to	95.5V		70		dB	
Input Impedance									
Input voltage Range	VIN	VDD = PVDD	= 1.8~5.	5V	-0.3		VDD +0.3	V	
	K <sub>IN</sub>	Gain = 14dB, I	BW = 20	Hz		65			
Input Resistance Differential		Gain = 14dB, BW = 300Hz				72		KΩ	
		Gain = 8dB, BW = 20Hz				98			
		Gain = 8dB, D	B = 300H	Hz 102 20Hz corner, 14dB gain 2 8					
Output DC Offset	VOFF	Input shorted to GND, 20Hz corner, 14dB gain VDD = PVDD = 3.3V				2	8	mV	
	VINOFF	Gain = 14dB E	3W = 20H	łz, PVDD = 5V	corner, 14dB gain   2     VDD = 5V   0.14				
Input DC Offset Dynamic Range		Gain = 14dB, BW = 300Hz, PVDD = 5V				1.50		V	
Max. with Output VOFF < 200mV		Gain = 8dB, BW = 20Hz, PVDD = 5V				0.25			
		Gain = 8dB, B	W = 300	Hz, PVDD = 5V		1.8 6.0   180 200 225   2.0 2.5   1.3 1.8   0.9 1.2   65 1   70 1   65 70   70 1   65 70   70 1   65 70   70 1   65 70   70 1   65 102   72 2   98 102   102 2   8 0.14   1.50 2.70   360 350   490 460   490 460   600 <sup>†</sup> 600 <sup>†</sup> 14 8   150 1.75   1.65 1.75			
				P Channel		360			
		VDD = PVDD=	-57	N Channel		350	P   Max     6.0     225     2.5     3   1.8     9   1.2     1   1     1   <	-	
VDD = PVDD = 1.8VSupply Current, Shutdown ModeIQQSDDisable Pin activePVDPower Supply Rejection RatioPSRRVDD = PVDD = 1.8V to 5.5VImput to 5.5VCommon Mode Rejection RatioCMRRVDD = PVDD = 1.8V to 5.5VImput to 5.5VInput ImpedanceImput voltage RangeVINVDD = PVDD = 1.8-5.5VImput to 5.5VInput voltage RangeVINVDD = PVDD = 1.8-5.5VImput state 1.44B, BW = 20HzImput state 1.44B, BW = 20HzInput Resistance DifferentialGain = 14dB, BW = 300HzImput state 3.3VImput state 3.3VOutput DC OffsetVOFFInput shorted to GND, 20Hz corner, 14dB gain VDD = PVDD = 3.3VImput state 3.3VOutput DC Offset Dynamic Range Max. with Output VOFF < 200mV		490		]					
Resistance	RDSON	VDD = PVDD=3.3V		N Channel		460		- mΩ	
				P Channel		600 <sup>†</sup>			
		VDD - FVDD-	-1.0V	N Channel		600 <sup>†</sup>		1	
Stago Gain	GH	Pin 9 tied to V	Pin 9 tied to VDD, VDD = PVDD = 1.8V to 5.5V			14		dB	
Stage Gain	GL	Pin 9 tied to VSS, VDD = PVDD = 1.8V to 5.5V			8		UD		
Thermal Indicator Junction	TJ					150		°C	
Thermal Indicator Output	VTOVL	VDD = PVDD = 1.8~5.5V				VDD		V	
Under Voltage Threshold Level	VUV				1.55	1.65	1.75	V	
Enable Threshold VDD = PVDD =3.3V		1.3	1.5	1.7	V				

† At +85°C ambient temperature.

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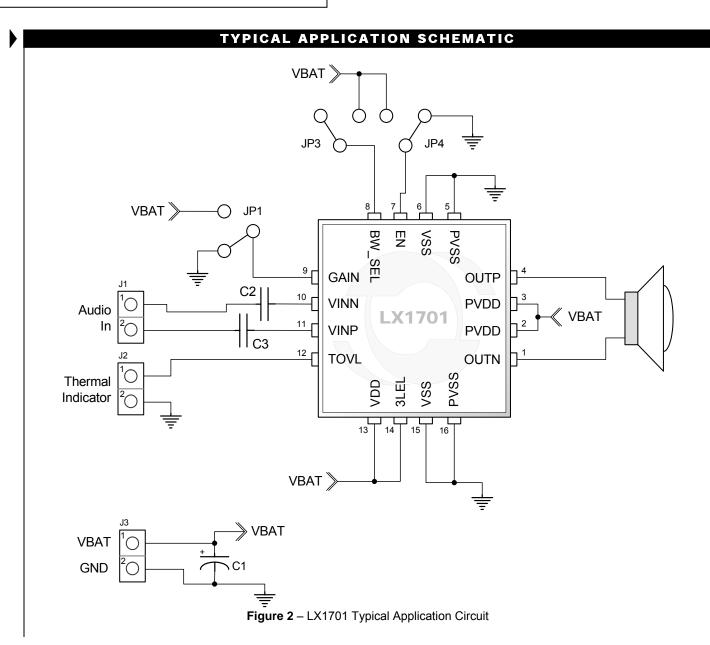


2W Filterless Mono Class-D Audio Amplifier





2W Filterless Mono Class-D Audio Amplifier





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**PRODUCTION DATA SHEET** 

### FUNCTIONAL DESCRIPTION

#### **GENERAL DESCRIPTION**

The LX1701 is a filterless, low-EMI, class-D audio power amplifier. It offers high performance (THD+N is just 0.1% at 2W), high efficiency (>85% at 1.2W), and best in class EMI radiation (just 20dBuV/m). The internal signal path is completely differential to minimize commonmode noise pickup. The inputs may be driven single-ended or differentially and they may be direct or AC coupled. The LX1701 may be operated with just a single decoupling capacitor.

#### FILTERLESS 3-LEVEL CLASS-D MODULATION

The LX1701 output stage is configured as a full H-bridge push-pull driver. The speaker must be driven differentially from the OUTP and OUTN pins. Each side of the speaker is driven by a 200KHz switching signal that transitions between Vdd and GND. With zero input voltage, the duty cycle at each output is around 50% and the signals are inphase with each other. In this case, there is basically no differential voltage across the speaker. When the input signal goes positive, the duty cycle at OUTP increases above 50% and the duty cycle at OUTN decreases below 50%. This causes a net positive current to flow into the speaker. A negative input voltage causes the OUTN duty cycle to increase and the OUTP duty cycle to decrease which causes a net negative current to flow into the speaker. The differential voltage across the speaker has a fundamental frequency of twice the 200KHz switching frequency. The speaker itself serves as the low pass filter which then recreates the audio signal. This type of modulation can be described as driving +Vdd, -Vdd, and 0V across the speaker which is why it is referred to as 3-Level modulation.

Classical, 2-Level modulation drives either +Vdd or -Vdd across the speaker at all times. This scheme requires an L-C filter between the amplifier's outputs and the speaker in order to keep the output current low.

# LOW-EMI OUTPUT STAGE WITH SLEW RATE LIMITING AND ACTIVE OVERSHOOT CLAMPING

With 3-Level modulation, the carrier frequency drives a full amplitude common-mode signal to the speaker wires. This can cause high EMI radiation. One way to combat this would be to filter the outputs with L-C filters or ferrite beads located close to the amplifier. In the LX1701, the output stage has been carefully designed to minimize EMI radiation so that these types of filters are not required. Slew rate limiting is used to keep the outputs from switching too quickly. Active overshoot clamping is used to minimize the inductive overshoot which occurs at each transition. These two techniques allow the LX1701 to easily meet FCC standards for radiated emissions when driving up to 3 meters of speaker wire.

### ACTIVE DC INPUT OFFSET CANCELLATION

An internal DC servo loop senses the output differential voltage and feeds it back to the error amplifier through a low pass filter. The corner frequency of this filter can be set at 20Hz or 300Hz via a control pin. This allows the LX1701 to reject signals below these frequencies. Since this is an active control loop, it does not have the same dynamic range as a purely passive solution (such as an input AC-coupling capacitor). The dynamic range of the offset cancellation loop is a function of the selected gain and high pass corner frequency. In applications where the input offset may be higher than the DC offset cancellation range, AC-coupling capacitors should be used.

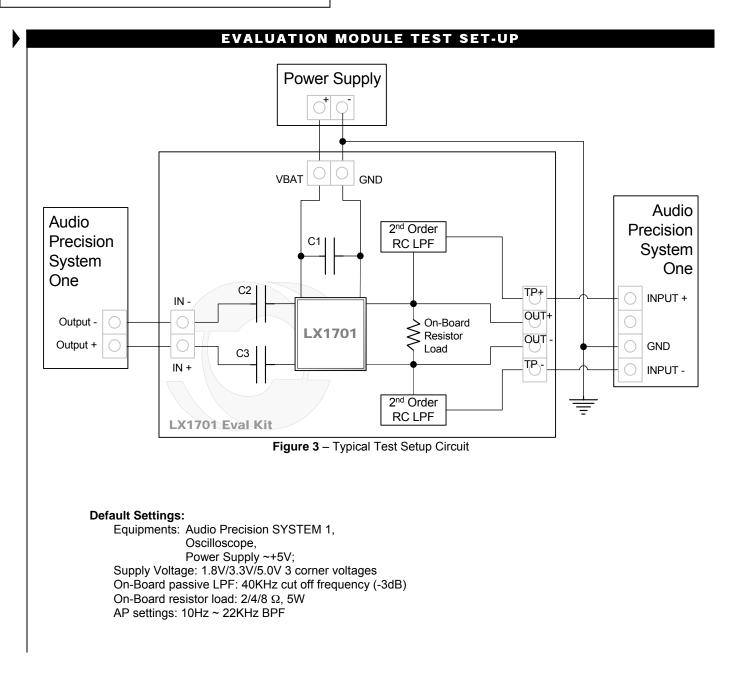
#### DIFFERENTIAL SIGNAL PATH, WIDE DYNAMIC RANGE, AND BUILT-IN THERMAL OVERLOAD PROTECTION

The fully differential signal path uses delta-sigma techniques and multiple feedback loops to provide high performance and low distortion. This is all fully-integrated to eliminate the need for any external feedback components or filters. The gain can be selected to be either 8 or 14dB by a control pin. The differential signal path and internal voltage boosters allow for wide dynamic range. In fact, the LX1701 can be operated from supplies as low as 1.8V and as high as 6V. The output power will be limited by the available supply voltage. An internal thermal sensing circuit shuts down the outputs and forces the TOVL output pin high when the junction temperature exceeds about 150degC to provide thermal overload protection.

DESCRIPTION



2W Filterless Mono Class-D Audio Amplifier





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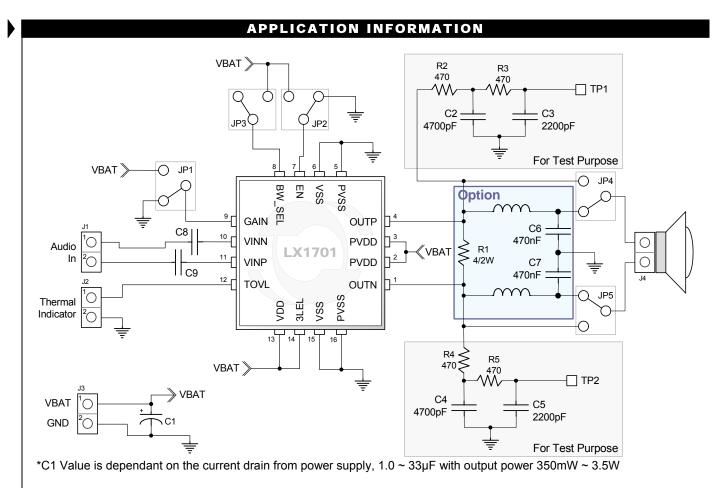


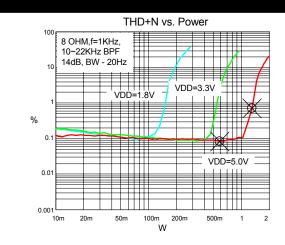
Figure 4 – LXE1701 Evaluation Module Schematic



### 2W Filterless Mono Class-D Audio Amplifier

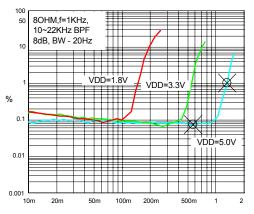
#### **PRODUCTION DATA SHEET**

THD+N vs. Power

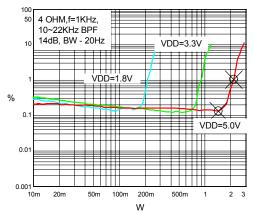


100 8 OHM,f=1KHz, 50 10~22KHz BPF 14dB, BW - 300Hz VDD=3.3V VDD=1 8V % 0. X HT VDD=5.0V 0.01 0.001 10m 20m 50m 100m 200m 500m 1 2

THD+N vs. Power

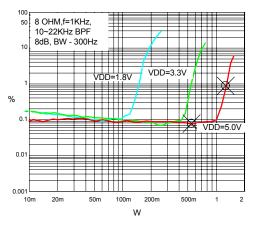


THD+N vs. Power

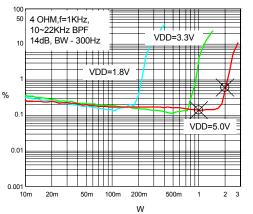


THD+N vs. Power

w



THD+N vs. Power



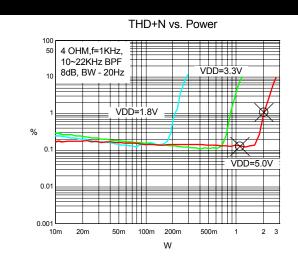
CHARTS

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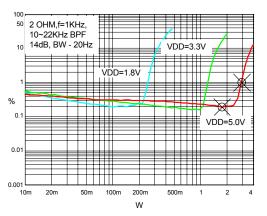
### 2W Filterless Mono Class-D Audio Amplifier

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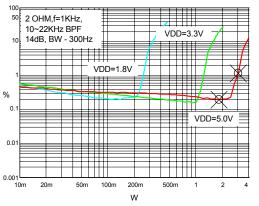


THD+N vs. Power 100 4 OHM,f=1KHz, 50 10~22KHz BPF 8dB, BW - 300Hz VDD=3.3V 10 ++ VDD=1.8V % ÌЩ 0.1 VDD=5.0V 0.01 0.001 200m 10m 20m 50m 100m 500m 1 2 3 W

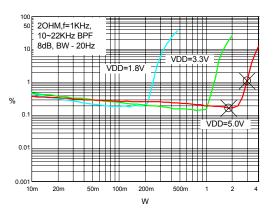
THD+N vs. Power



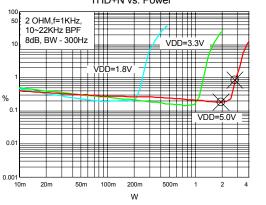
THD+N vs. Power



THD+N vs. Power



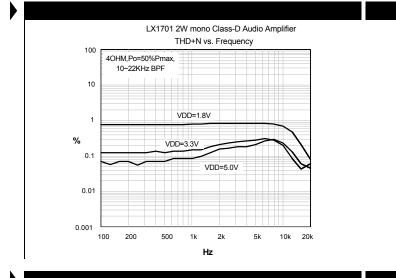
THD+N vs. Power



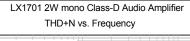


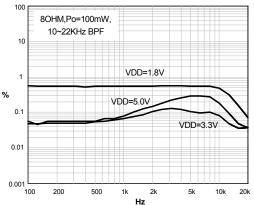
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LX1701 2W mono Class-D Audio Amplifier THD+N vs. Frequency 100 40HM.Po=100mW. 10~22KHz BPF 10 VDD=1.8V 1 VDD=5 0V % 0.1 VDD=3.3V 0.01 0.001 20k 100 200 500 2k 5k 10k 1k Hz





LX1701 2W mono Class-D Audio Amplifier

VDD=1.8V/3.3V/5.0V

5k 10k

50k 80k

500 1k

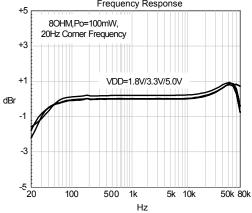
Hz

Frequency Response

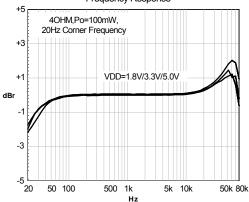
80HM,Po=100mW,

300Hz Corner Frequency

LX1701 2W mono Class-D Audio Amplifier Frequency Response



LX1701 2W mono Class-D Audio Amplifier Frequency Response



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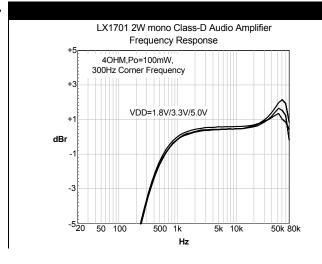
50 100

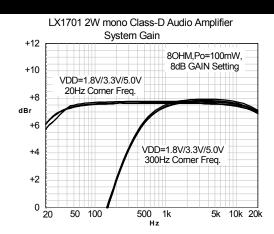
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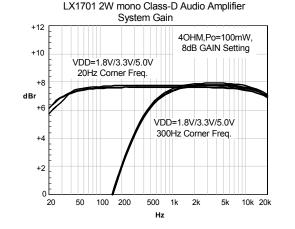


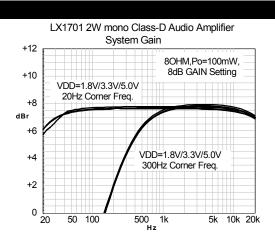
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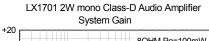


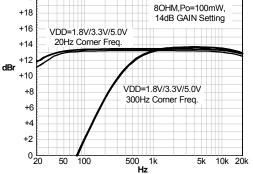




LX1701 2W mono Class-D Audio Amplifier System Gain +2040HM,Po=100mW, +18 14dB GAIN Setting VDD=1.8V/3.3V/5.0V +16 20Hz Corner Freq. +14 +12 dBr +10 VDD=1.8V/3.3V/5.0V +8 300Hz Corner Freq. +6 +4 +2 0 20 50 100 200 500 1k 2k 5k 10k 20k

Hz

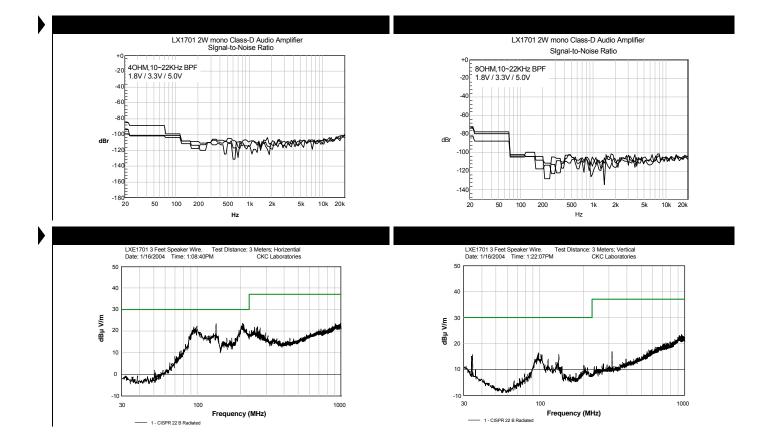






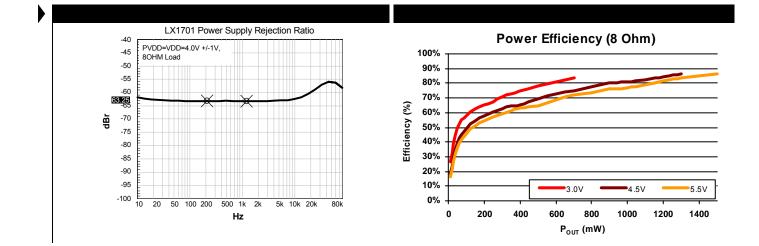
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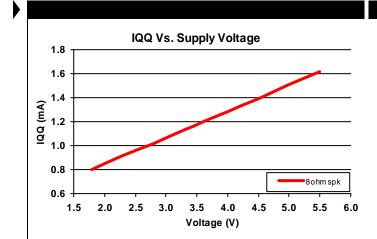
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#### **PRODUCTION DATA SHEET**

PCB DESIGN GUIDELINES

#### PCB DESIGN GUIDELINES

One of the key efforts in implementing the MLP package on a pc board is the design of the land pattern. The MLP has rectangular metallized terminals exposed on the bottom surface of the package body. Electrical and mechanical connection between the component and the pc board is made by screen printing solder paste on the pc board and reflowing the paste after placement. To guarantee reliable solder joints it is essential to design the land pattern to the MLP terminal pattern, exposed PAD and Thermal PAD via. There are two basic designs for PCB land pads for the MLP: Copper Defined style (also known as Non Solder Mask Defined (NSMD)) and the Solder Mask Defined style (SMD). The industry has had some debate of the merits of both styles of land pads, and although we recommend the Copper Defined style land pad (NSMD), both styles are acceptable for use with the MLP package. NSMD pads are recommended over SMD pads due to the tighter tolerance on copper etching than solder masking. NSDM by definition also provides a larger copper pad area and allows the solder to anchor to the edges of the copper pads thus providing improved solder joint reliability.

# DESIGN OF PCB LAND PATTERN FOR PACKAGE TERMINALS

As a general rule, the PCB lead finger pad (Y) should be designed 0.2-0.5mm longer than the package terminal length for good filleting. The pad length should extended 0.05mm towards the centerline of the package. The pad width (X) should be a minimum 0.05mm wider than the package terminal width (0.025mm per side), refer to figure 5. However, the pad width is reduced to the width of the component terminal for lead pitches below 0.65mm. This is done to minimize the risk of solder bridging.

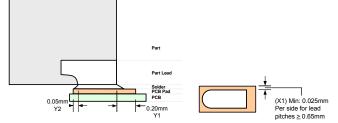
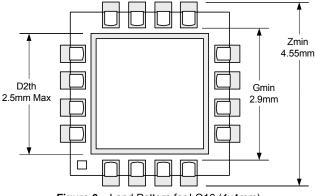


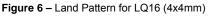
Figure 5 – PC Board Land Pattern Geometry for MLP Terminals

#### EXPOSED PAD PCB DESIGN

The construction of the Exposed Pad MLP enables enhanced thermal and electrical characteristics. In order to take full advantage of this feature the exposed pad must be physically connected to the PCB substrate with solder.

The thermal pad (D2th) should be greater than D2 of the MLP whenever possible, however adequate clearance (Cpl > 0.15mm) must be met to prevent solder bridging. If this clearance cannot be met, then D2th should be reduced in area. The formula would be: D2TH >D2 only if D2TH < Gmin - (2 x Cpl).





Zmin= D + aaa + 2(0.2)(where pkg body tolerance aaa=0.15) (where 0.2 is outer pad extension) Gmin= D-2(Lmax)-2(0.05)(where 0.05 is inner pad extension) (Lmax=0.50 for this example) D2th max = Gmin-2(CpL)(where CpL=0.2)



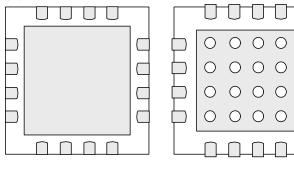
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### PCB DESIGN GUIDELINES (CONTINUED)

#### THERMAL PAD VIA DESIGN

There are two types of on-board thermal PAD design, one is using thermal vias to sink the heat to the other layer with metal traces. Based on Jedec Specification JESD 51-5, the thermal vias should be designed like Figure 7. Another one is the no via thermal PAD which is using the same side copper PAD as heatsink, this type of thermal PAD is good for two layer board, since the bottom side is filled with all other kinds of trace also, it's hard to use the whole plane for the heatsink. But you still can use vias to sink the heat to the bottom layer by the metal traces, then layout a NMSD on which a metal heatsink is put to sink the heat to the air.



Micro Lead Quad Package Land Pattern Land Pattern for Four Layer Board with Vias

Figure 7 – Comparison of land pattern theory

For LX1701 with MLPQ-4x4 16Lds p ackage, which has  $\theta jA = 38.1^{\circ}C/W$  by package itself, with maximum 2W (@4ohm) output it only has 300mW power dispassion (assuming 85% efficiency), which only has 11.4°C temperature rise. So the non-via type thermal PAD is suggested.

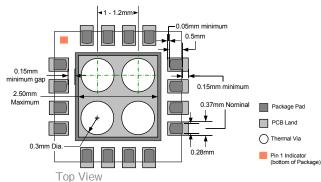
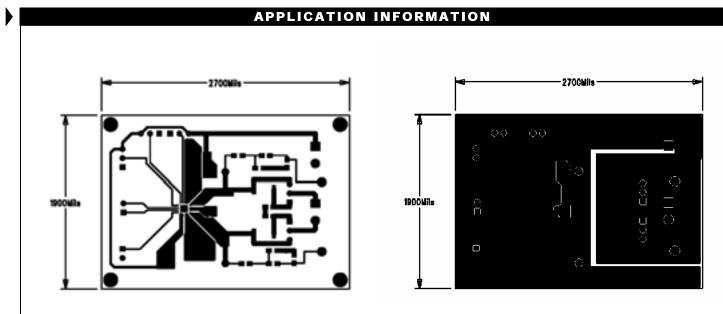


Figure 8 – Recommended Land Pad with Vias for LQ16



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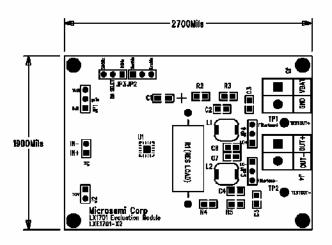


Figure 9 – LXE1701 Evaluation Module PCB Layout

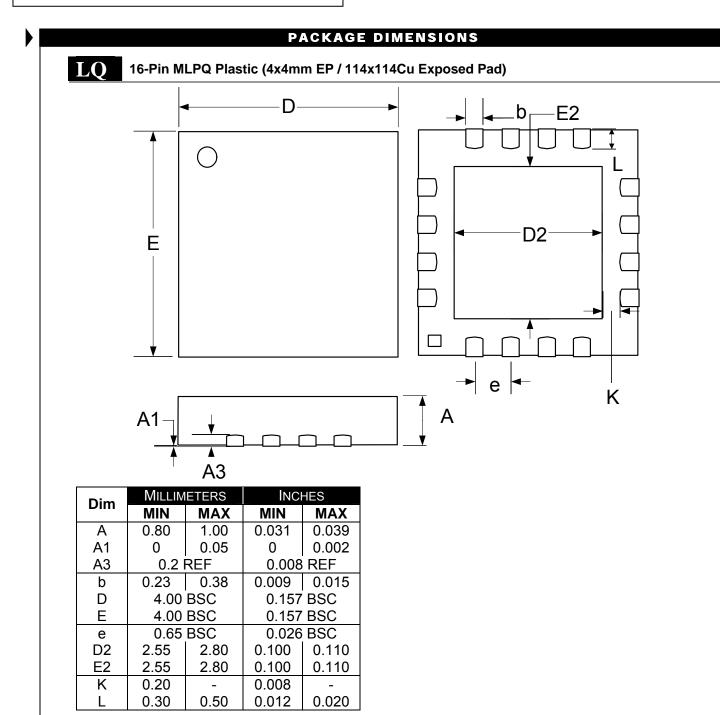


Figure 10 – LX1701 real PCB area with decoupling capacitor



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Note:

1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.



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